



Chip Inductors for RF Applications (Wire wound-open)

FASTRON wire wound chip inductors are designed particularly for RF applications that require optimal Q on high frequency circuits. Its gold flash pad metallization provides better solderability for a higher yield in your production. In addition, their encapsulation not only protects the winding but also allows surface mount assembly. It comes in compact sizes (from 0402 to 1812) available in reel packing. Inductance values between those listed in this catalog are mostly available on request. Ferrite core versions are also available for selected case sizes for applications which require higher inductances in a smaller case size.

Applications Used in LC resonant circuits such as oscillator and signal generators, impedance matching, RF filters etc.
 Mobile Telecommunication: GSM, CDMA, TCDMA, cordless phones, 2 way radio
 Automotive Subsystems: TPMS, Keyless Entry, Anti-Theft, GPS
 Wireless Communication: W-LAN, WIFI, WIMAX, RFID, Bluetooth

Technical Data

L – Value (rated inductance)	≥ 1 MHz measured with HP 4286A RF LCR meter at frequency f_L < 1 MHz measured with HP 4194A RF LCR meter at frequency f_L
Q – Factor (min)	≥ 1 MHz measured with HP 4287A RF LCR meter at frequency f_Q < 1 MHz measured with HP 4194A RF LCR meter at frequency f_Q
SRF (min)	Measured with HP 8753ES Network Analyzer
DCR (max)	Measured at 25°C
Operating Temperature	For ceramic core from -40°C to +150°C (Includes component self-heating) For ferrite core from -40°C to +85°C
Surface Finishing	Epoxy molded flat top for perfect pick and place assembly
Pad Metallization	Gold flash as top layer
Wire Termination	Spot welding
Recommended soldering method	Reflow
Moisture Sensitivity Levels (MSL)	MSL Level 1, indicating unlimited floor life at ≤ 30°C / 85% relative humidity
Solderability	Using lead free solder (Sn 99.9) at 260°C ± 5°C for 5 ± 0.5 seconds, min 90% solder coverage of metallization Standard: IEC 68-2-20 (Ta)
Resistance to Soldering Heat	Resistant to 260°C ± 5°C for 10 ± 1 seconds Standard: IEC 68-2-20 (Tb)
Resistance to Solvent	Resistant to Isopropyl alcohol for 5 ± 0.5 minutes at 23°C ± 5°C Standard: IEC 68-2-45
Climatic Test	Defined by the following standards IEC 68-2-1 for Cold test: -55°C for 96 hours IEC 68-2-2 for Dry heat test: +85°C for ferrite core and 125°C for ceramic core for 96 hours IEC 60068-2-78 for Humidity test: 40°C at RH 95% for 4 days
Thermal Shock Test	Temperature cycle (ceramic) : -40°C to +125°C to -40°C Temperature cycle (ferrite) : -40°C to +85°C to -40°C Max/Min temperature duration: 15 minutes Temperature transition duration: 5 minutes Cycles: 25 Standard: MIL-STD-202G
Adhesion of Soldered Component (Shear Test)	Components withstand a pushing force of 10N for 10 ± 1 seconds Standard: IEC 60068-2-21, method Ue3
Mechanical Shock	Mil-Std 202 Method 213, Condition C 3 axis, 6 times, total 18 shocks 100 G, 6 ms, half-sine
Vibration	Mil-Std 202 Method 204 20 mins at 5G 10 Hz to 2000 Hz 12 cycles each of 3 orientations

Ordering Code Example: 0402AS-1N0X-YY ➔ **0402AS-1N0K-01**

0402 **AS** - **1N0** **X** - **YY**
 (Case Size) (Core Type) (Inductance Value) (Tolerance) (Packing Code)

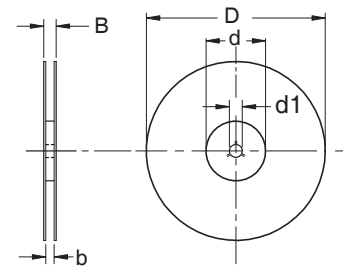
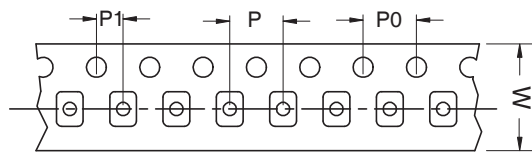
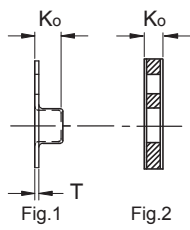
- Case Sizes - 0402, 0603, 0805, 1008, 1206, 1210, 1812
- Core Type - AS, AQ (Ceramic), F (Ferrite), AF (Ceramic & Ferrite)
- Tolerances - F (1%), G (2%), A (3%), J (5%), K (10%), M (20%)
- Packing Code - 01, 04, 08 (Reel)

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Packing Specification



drawing only schematic, see table

Type	Packing Code	D	d	d1	B	b	W	P	P0	P1	Ko	T	Fig
0402	01,08	180	60	13	12.7	8.4	8	2	4	2	0.6	-	2
0603	01,08	180	60	13	12.7	8.4	8	4	4	2	1.0	0.25	1
0603	04	330	100	13	14.4	8.4	8	4	4	2	1.0	0.25	1
0805	01	180	60	13	12.7	8.4	8	4	4	2	1.63	0.25	1
0805	04	330	100	13	14.4	8.4	8	4	4	2	1.63	0.25	1
1008	01	180	60	13	12.7	8.4	8	4	4	2	2.23	0.3	1
1008	04	330	100	13	14.4	8.4	8	4	4	2	1.63	0.25	1
1206	01	180	60	13	12.7	8.4	8	4	4	2	1.8	0.2	1
1206	04	330	100	13	14.4	8.4	8	4	4	2	1.8	0.2	1
1210	01	180	60	13	18.4	13.7	12	8	4	2	2.55	0.3	1
1210	04	330	100	13	18.4	12.4	12	8	4	2	2.55	0.3	1
1812	01	180	60	13	18.4	13.7	12	8	4	2	3.70	0.35	1
1812	04	330	100	13	18.4	12.4	12	8	4	2	3.70	0.35	1

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